



# FDS8449\_F085

## 40V N-Channel PowerTrench<sup>®</sup> MOSFET

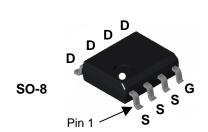
### **General Description**

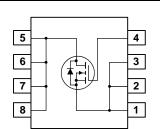
These N-Channel MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

## Application

- Inverter
- **Power Supplies**







## Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol		Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Sourc	e Voltage		40	V
V <sub>GSS</sub>	Gate-Sourc	e Voltage		±20	V
I <sub>D</sub>	Drain Curre	nt – Continuous	(Note 1a)	7.6	А
		– Pulsed		50	
P <sub>D</sub>	Power Dissi	pation for Single Operation	n (Note 1a)	2.5	W
			(Note 1b)	1	
$T_J, T_{STG}$	Operating a	nd Storage Junction Temp	perature Range	-55 to +150	°C
Therma	I Charac	teristics			
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Amb	ient (Note 1a)	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1b)		ient (Note 1b)	125	
$R_{\theta JC}$	Thermal Re	sistance, Junction-to-Case	e (Note 1)	25	
Packag	e Markin	g and Ordering I	nformation		
Device Marking		Device	Reel Size	Tape width	Quantity

Device Marking	Device	Reel Size	Tape width	Quantity
FDS8449	FDS8449_F085	13"	12mm	2500 units

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## **Features**

7.6 A, 40V 
$$R_{DS(on)} = 29m\Omega @ V_{GS} = 10V$$

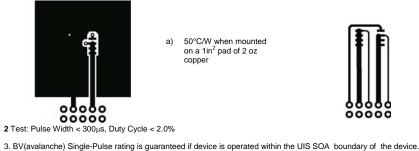
 $\mathrm{R}_{\mathrm{DS(on)}} = 36 \mathrm{m}\Omega ~ @ ~ \mathrm{V}_{\mathrm{GS}} = 4.5 \mathrm{V}$ 

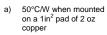
July 2009

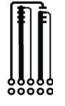
- High power handling capability in a widely used • surface mount package
- **RoHS** compliant
- Qualified to AEC Q101

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Not	e 3)		•	•	
E <sub>AS</sub>	Drain-Source Avalanche Energy	$V_{DD} = 40 \text{ V},  I_D = 7.3 \text{ A}, \text{ L} = 1 \text{ mH}$			27	mJ
I <sub>AS</sub>	Drain-Source Avalanche Current			7.3		А
Off Char	acteristics	•				
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	40			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		34		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 32 \text{ V},  V_{GS} = 0 \text{ V}$			1	μΑ
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , Referenced to $25^{\circ}C$		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = 10 \text{ V}, \qquad I_D = 7.6 \text{ A}$		21	29	mΩ
	On–Resistance	$V_{GS} = 4.5 \text{ V},  I_D = 6.8 \text{ A}$		26 29	36 43	
		$V_{GS}$ = 10 V, $I_D$ = 7.6 A, $T_J$ =125°C		-	43	
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_D = 7.6 \text{ A}$		21		S
	Characteristics			700		-
Ciss	Input Capacitance	$V_{DS} = 20 V, V_{GS} = 0 V,$		760		pF
Coss	Output Capacitance	f = 1.0 MHz		100		pF
Crss	Reverse Transfer Capacitance	6 4 0 MUL		60 1.2		pF
R <sub>G</sub>	Gate Resistance	f = 1.0 MHz		1.2		Ω
	g Characteristics (Note 2)				40	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 20 \text{ V},  I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$		9	18	ns
t <sub>r</sub>	Turn–On Rise Time			5	10	ns
t <sub>d(off)</sub>	Turn–Off Delay Time Turn–Off Fall Time	_		23 3	17 6	ns
t <sub>f</sub> Q <sub>q</sub>	Total Gate Charge			7.7	11	ns nC
Q <sub>g</sub> Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = 20 \text{ V}, \qquad I_D = 7.6 \text{ A},$ $V_{GS} = 5 \text{ V}$		2.4	11	nC
Q <sub>gs</sub> Q <sub>gd</sub>	Gate-Drain Charge	$ V_{GS} = 5$ V		2.4		nC
	<b>.</b>			2.0		
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = 2.1 A$ (Note 2)		0.76	1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time			17		nS
Q <sub>rr</sub>	Diode Reverse Recovery Charge	$I_F = 7.6 \text{ A}, \qquad d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		7		nC







b) 125°C/W when mounted on a minimum pad.

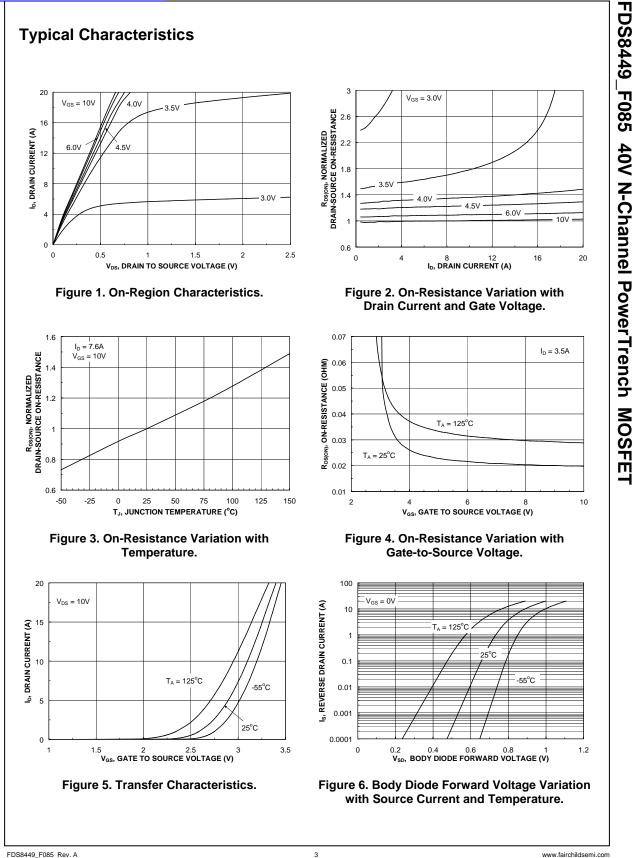
Scale 1 : 1 on letter size paper

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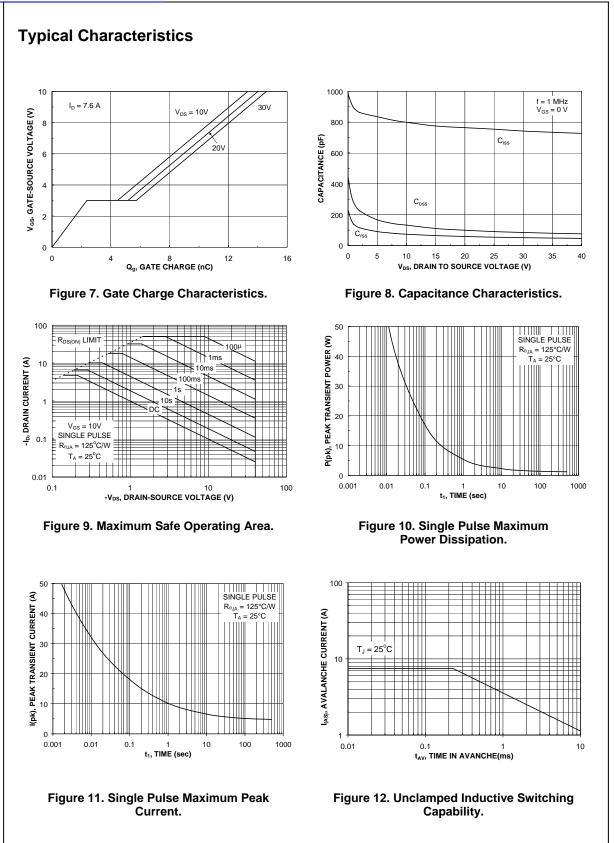
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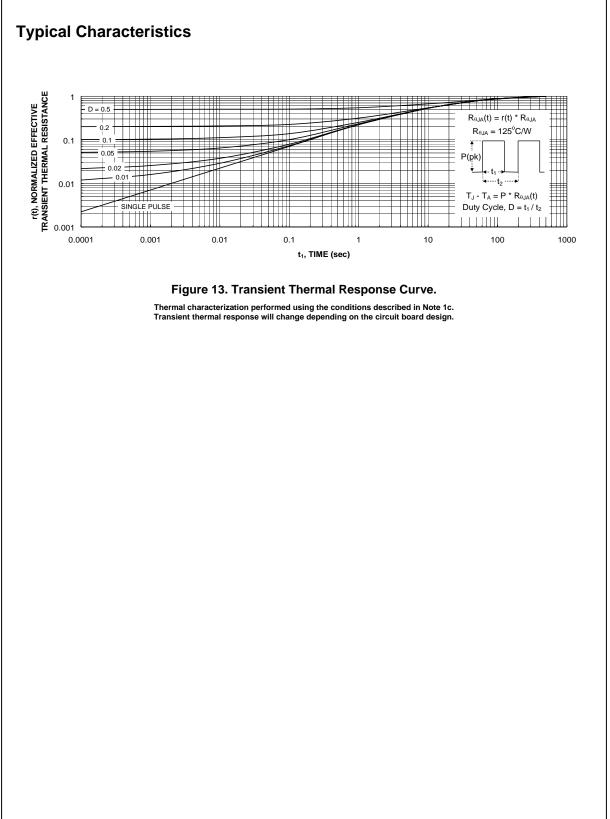


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